

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10046893	01/17/2002	438	149	2812	H. Lee

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****CONTINUING DATA VERIFIED:** Lee
NOTE

**** FOREIGN APPLICATIONS VERIFIED:** Lee
JAPAN 2001-010890 01/18/2001
JAPAN 2001-019357 01/29/2001 Yes
JAPAN 2001-022398 01/30/2001

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		740756-2424
Verified and Acknowledged Examiners's initials Lee		
TITLE : Method of manufacturing semiconductor device		

U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drawg.	Fig. Drawg. Print Fig.
		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
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